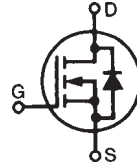


Trench Gate Power MOSFET

IXTH86N25T
IXTQ86N25T
IXTV86N25T

N-Channel Enhancement Mode
Avalanche Rated

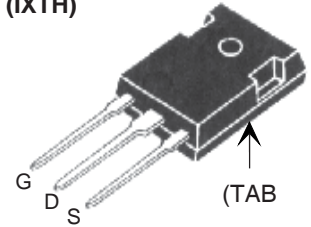


| Symbol | Test Conditions | Maximum Ratings | |
|---------------|--|--------------------|------------------|
| V_{DSS} | $T_J = 25^\circ\text{C}$ to 150°C | 250 | V |
| V_{DGR} | $T_J = 25^\circ\text{C}$ to 150°C , $R_{GS} = 1\text{M}\Omega$ | 250 | V |
| V_{GSM} | Transient | ± 30 | V |
| I_{D25} | $T_C = 25^\circ\text{C}$ | 86 | A |
| I_{LRMS} | Lead Current Limit, RMS | 75 | A |
| I_{DM} | $T_C = 25^\circ\text{C}$, pulse width limited by T_{JM} | 190 | A |
| I_{AS} | $T_C = 25^\circ\text{C}$ | 10 | A |
| E_{AS} | $T_C = 25^\circ\text{C}$ | 1.5 | J |
| P_D | $T_C = 25^\circ\text{C}$ | 540 | W |
| T_J | | -55 ... +150 | $^\circ\text{C}$ |
| T_{JM} | | 150 | $^\circ\text{C}$ |
| T_{stg} | | -55 ... +150 | $^\circ\text{C}$ |
| T_L | 1.6mm (0.062 in.) from case for 10s | 300 | $^\circ\text{C}$ |
| T_{SOLD} | Plastic body for 10 seconds | 260 | $^\circ\text{C}$ |
| M_d | Mounting torque (TO-247 & TO-3P) | 1.13 / 10 | Nm/lb.in. |
| F_C | Mounting force (PLUS220) | 11..65 / 2.5..14.6 | N/lb. |
| Weight | TO-247 | 6.0 | g |
| | TO-3P | 5.5 | g |
| | PLUS220 | 4.0 | g |

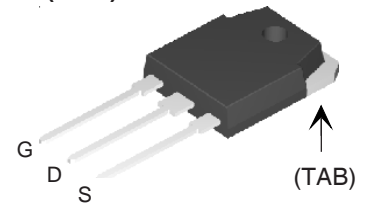
| Symbol | Test Conditions ($T_J = 25^\circ\text{C}$ unless otherwise specified) | Characteristic Values | | |
|--------------|---|-----------------------|------|-------------------|
| | | Min. | Typ. | Max. |
| BV_{DSS} | $V_{GS} = 0\text{V}$, $I_D = 250\mu\text{A}$ | 250 | | V |
| $V_{GS(th)}$ | $V_{DS} = V_{GS}$, $I_D = 1\text{mA}$ | 3 | | 5 V |
| I_{GSS} | $V_{GS} = \pm 20\text{V}$, $V_{DS} = 0\text{V}$ | | | ± 200 nA |
| I_{DSS} | $V_{DS} = V_{DSS}$ $V_{GS} = 0\text{V}$ $T_J = 125^\circ\text{C}$ | | | 3 μA |
| | | | | 250 μA |
| $R_{DS(on)}$ | $V_{GS} = 10\text{V}$, $I_D = 0.5 \cdot I_{D25}$, Notes 1, 2 | | | 37 m Ω |

$V_{DSS} = 250\text{V}$
 $I_{D25} = 86\text{A}$
 $R_{DS(on)} \leq 37\text{m}\Omega$

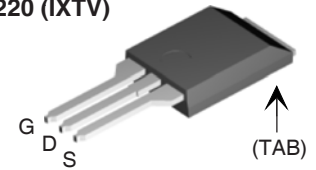
TO-247 (IXTH)



TO-3P (IXTQ)



PLUS220 (IXTV)



G = Gate D = Drain
S = Source TAB = Drain

Features

- International standard packages
- Avalanche rated
- Low package inductance
 - easy to drive and to protect

Advantages

- Easy to mount
- Space savings
- High power density

Applications

- DC-DC converters
- Battery chargers
- Switched-mode and resonant-mode power supplies
- DC choppers
- AC motor control
- Uninterruptible power supplies

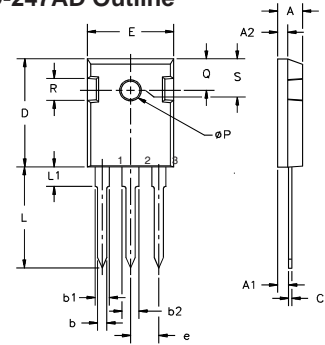
| Symbol | Test Conditions | Characteristic Values | | |
|---|--|-----------------------|------|--------------------|
| | | Min. | Typ. | Max. |
| $(T_J = 25^\circ\text{C unless otherwise specified})$ | | | | |
| g_{fs} | $V_{DS} = 10\text{V}, I_D = 0.5 \cdot I_{D25}$, Note 1 | 45 | 76 | S |
| C_{iss} | $V_{GS} = 0\text{V}, V_{DS} = 25\text{V}, f = 1\text{MHz}$ | | 5330 | pF |
| C_{oss} | | | 515 | pF |
| C_{rss} | | | 92 | pF |
| $t_{d(on)}$ | Resistive Switching Times $V_{GS} = 10\text{V}, V_{DS} = 0.5 \cdot V_{DSS}, I_D = 0.5 \cdot I_{D25}$ $R_G = 3.3\Omega$ (External) | | 22 | ns |
| t_r | | | 28 | ns |
| $t_{d(off)}$ | | | 55 | ns |
| t_f | | | 25 | ns |
| $Q_{g(on)}$ | $V_{GS} = 10\text{V}, V_{DS} = 0.5 \cdot V_{DSS}, I_D = 25\text{A}$ | | 105 | nC |
| Q_{gs} | | | 32 | nC |
| Q_{gd} | | | 28 | nC |
| R_{thJC} | | | 0.23 | $^\circ\text{C/W}$ |
| R_{thCS} | | | 0.25 | $^\circ\text{C/W}$ |

Source-Drain Diode

| Symbol | Test Conditions | Characteristic Values | | |
|---|---|-----------------------|------|---------------|
| | | Min. | Typ. | Max. |
| $T_J = 25^\circ\text{C unless otherwise specified}$ | | | | |
| I_S | $V_{GS} = 0\text{V}$ | | | 86 A |
| I_{SM} | Repetitive, pulse width limited by T_{JM} | | | 172 A |
| V_{SD} | $I_F = I_S, V_{GS} = 0\text{V}$, Note 1 | | | 1.5 V |
| t_{rr} | $I_F = 43\text{A}, -di/dt = 250\text{A}/\mu\text{s}$ $V_R = 100\text{V}, V_{GS} = 0\text{V}$ | | 156 | ns |
| I_{RM} | | | 21 | A |
| Q_{RM} | | | 1.7 | μC |

- Notes: 1. Pulse test, $t \leq 300\text{ms}$; duty cycle, $d \leq 2\%$.
2. On through-hole packages, $R_{DS(on)}$ Kelvin test contact location must be 5mm or less from the package body.

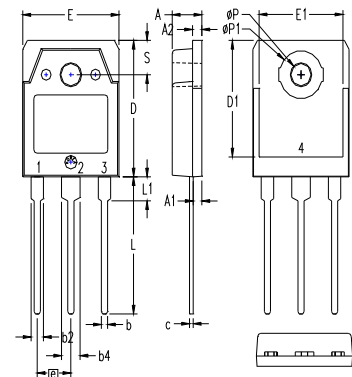
TO-247AD Outline



Terminals: 1 - Gate 2 - Drain
3 - Source Tab - Drain

| Dim. | Millimeter | | Inches | |
|----------------|------------|-------|--------|-------|
| | Min. | Max. | Min. | Max. |
| A | 4.7 | 5.3 | .185 | .209 |
| A ₁ | 2.2 | 2.54 | .087 | .102 |
| A ₂ | 2.2 | 2.6 | .059 | .098 |
| b | 1.0 | 1.4 | .040 | .055 |
| b ₁ | 1.65 | 2.13 | .065 | .084 |
| b ₂ | 2.87 | 3.12 | .113 | .123 |
| C | .4 | .8 | .016 | .031 |
| D | 20.80 | 21.46 | .819 | .845 |
| E | 15.75 | 16.26 | .610 | .640 |
| e | 5.20 | 5.72 | 0.205 | 0.225 |
| L | 19.81 | 20.32 | .780 | .800 |
| L ₁ | | 4.50 | | .177 |
| ∅EP | 3.55 | 3.65 | .140 | .144 |
| Q | 5.89 | 6.40 | 0.232 | 0.252 |
| R | 4.32 | 5.49 | .170 | .216 |
| S | 6.15 | BSC | 242 | BSC |

TO-3P (IXTQ) Outline

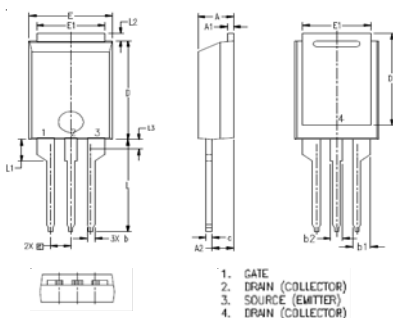


Pins: 1 - Gate 2 - Drain
3 - Source 4, TAB - Drain

| SYM | INCHES | | MILLIMETERS | |
|-----------------|--------|---------|-------------|----------|
| | MIN | MAX | MIN | MAX |
| A | .185 | .193 | 4.70 | 4.90 |
| A ₁ | .051 | .059 | 1.30 | 1.50 |
| A ₂ | .057 | .065 | 1.45 | 1.65 |
| b | .035 | .045 | 0.90 | 1.15 |
| b ₂ | .075 | .087 | 1.90 | 2.20 |
| b ₄ | .114 | .126 | 2.90 | 3.20 |
| c | .022 | .031 | 0.55 | 0.80 |
| D | .780 | .791 | 19.80 | 20.10 |
| D ₁ | .665 | .677 | 16.90 | 17.20 |
| E | .610 | .622 | 15.50 | 15.80 |
| E ₁ | .531 | .539 | 13.50 | 13.70 |
| e | | 215 BSC | | 5.45 BSC |
| L | .779 | .795 | 19.80 | 20.20 |
| L ₁ | .134 | .142 | 3.40 | 3.60 |
| L ₂ | .035 | .051 | 0.90 | 1.30 |
| L ₃ | .047 | .059 | 1.20 | 1.50 |
| ∅P | .126 | .134 | 3.20 | 3.40 |
| ∅P ₁ | .272 | .280 | 6.90 | 7.10 |
| S | .193 | .201 | 4.90 | 5.10 |

All metal area ore tin plated.

PLUS220 (IXTV) Outline



| SYM | INCHES | | MILLIMETER | |
|----------------|--------|----------|------------|----------|
| | MIN | MAX | MIN | MAX |
| A | .169 | .185 | 4.30 | 4.70 |
| A ₁ | .028 | .035 | 0.70 | 0.90 |
| A ₂ | .098 | .118 | 2.50 | 3.00 |
| b | .035 | .047 | 0.90 | 1.20 |
| b ₁ | .080 | .095 | 2.03 | 2.41 |
| b ₂ | .054 | .064 | 1.37 | 1.63 |
| c | .028 | .035 | 0.70 | 0.90 |
| D | .551 | .591 | 14.00 | 15.00 |
| D ₁ | .512 | .539 | 13.00 | 13.70 |
| E | .394 | .433 | 10.00 | 11.00 |
| E ₁ | .331 | .346 | 8.40 | 8.80 |
| e | | .100 BSC | | 2.54 BSC |
| L | .512 | .551 | 13.00 | 14.00 |
| L ₁ | .118 | .138 | 3.00 | 3.50 |
| L ₂ | .035 | .051 | 0.90 | 1.30 |
| L ₃ | .047 | .059 | 1.20 | 1.50 |

PRELIMINARY TECHNICAL INFORMATION

The product presented herein is under development. The Technical Specifications offered are derived from data gathered during objective characterizations of preliminary engineering lots; but also may yet contain some information supplied during a pre-production design evaluation. IXYS reserves the right to change limits, test conditions, and dimensions without notice.

IXYS reserves the right to change limits, test conditions, and dimensions.

| | | | | | | | | | | |
|--|-----------|-----------|-----------|-----------|--------------|--------------|--------------|--------------|--------------|-------------|
| IXYS MOSFETs and IGBTs are covered by one or more of the following U.S. patents: | 4,835,592 | 4,931,844 | 5,049,961 | 5,237,481 | 6,162,665 | 6,404,065 B1 | 6,683,344 | 6,727,585 | 7,005,734 B2 | 7,157,338B2 |
| | 4,850,072 | 5,017,508 | 5,063,307 | 5,381,025 | 6,259,123 B1 | 6,534,343 | 6,710,405 B2 | 6,759,692 | 7,063,975 B2 | |
| | 4,881,106 | 5,034,796 | 5,187,117 | 5,486,715 | 6,306,728 B1 | 6,583,505 | 6,710,463 | 6,771,478 B2 | 7,071,537 | |

Fig. 1. Output Characteristics @ 25°C

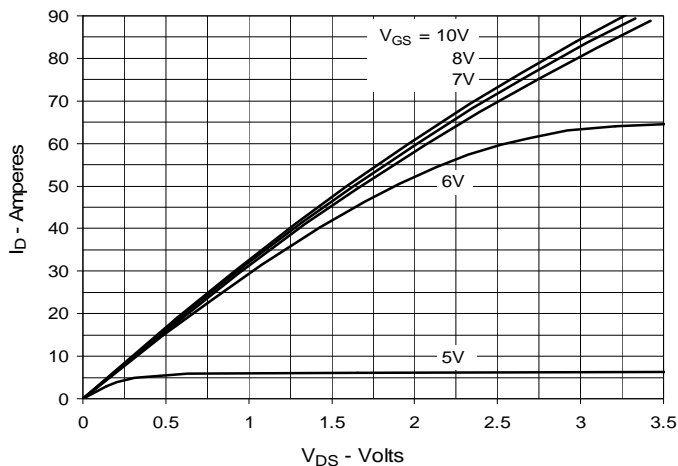


Fig. 2. Extended Output Characteristics @ 25°C

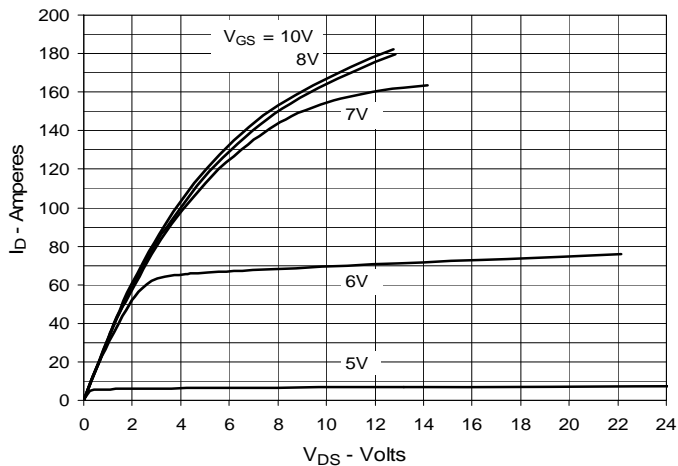


Fig. 3. Output Characteristics @ 125°C

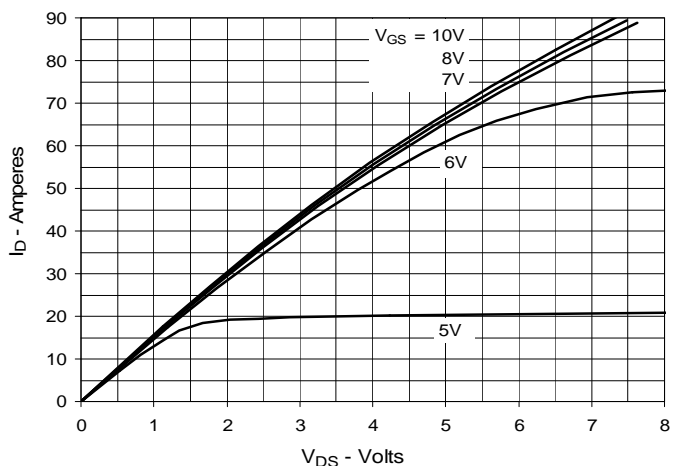


Fig. 4. $R_{DS(on)}$ Normalized to $I_D = 43A$ Value vs. Junction Temperature

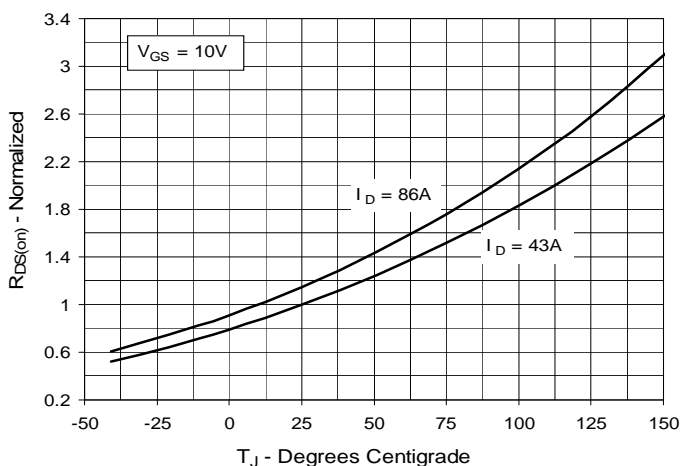


Fig. 5. $R_{DS(on)}$ Normalized to $I_D = 43A$ Value vs. Drain Current

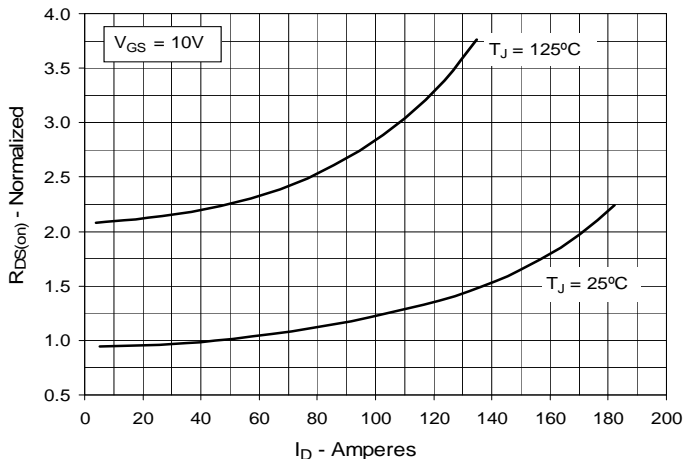


Fig. 6. Maximum Drain Current vs. Case Temperature

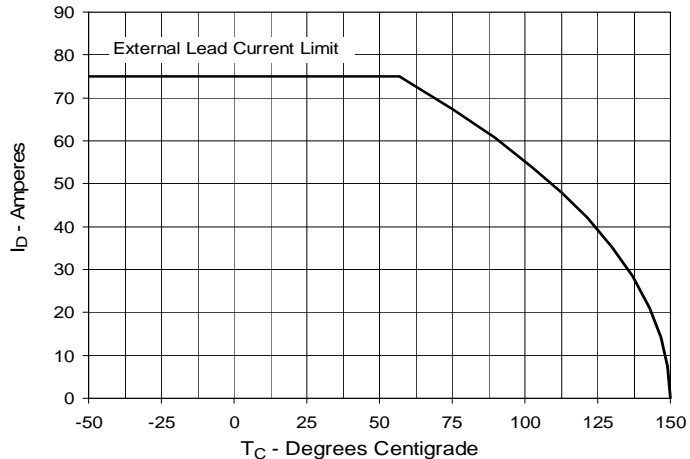


Fig. 7. Input Admittance

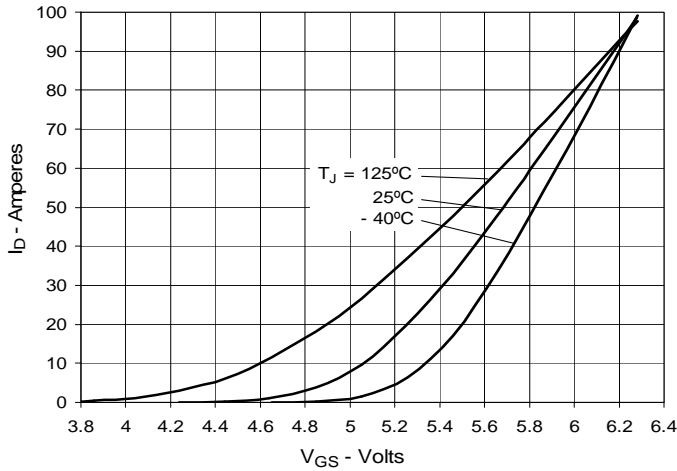


Fig. 8. Transconductance

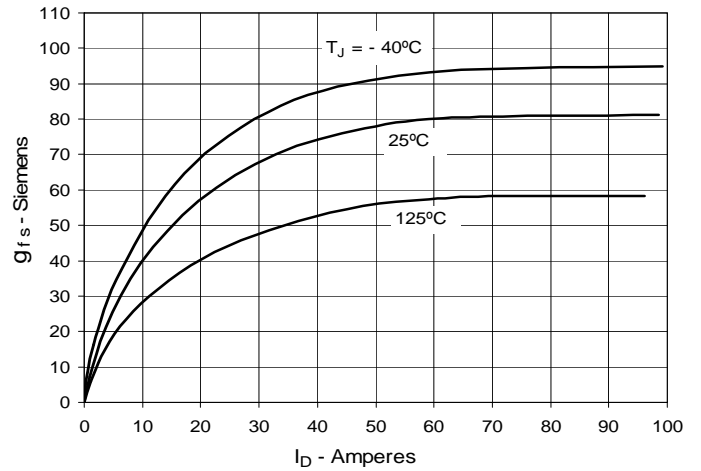


Fig. 9. Forward Voltage Drop of Intrinsic Diode

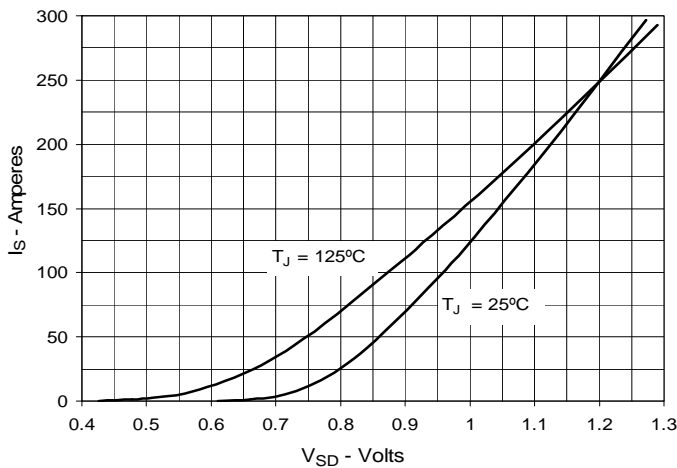


Fig. 10. Gate Charge

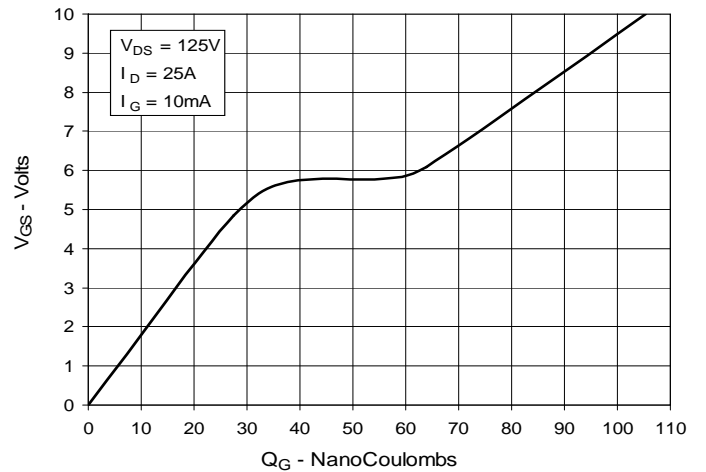


Fig. 11. Capacitance

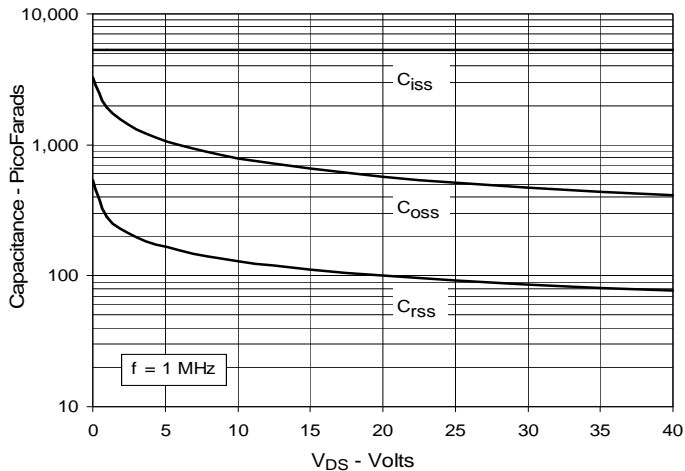


Fig. 12. Maximum Transient Thermal Impedance

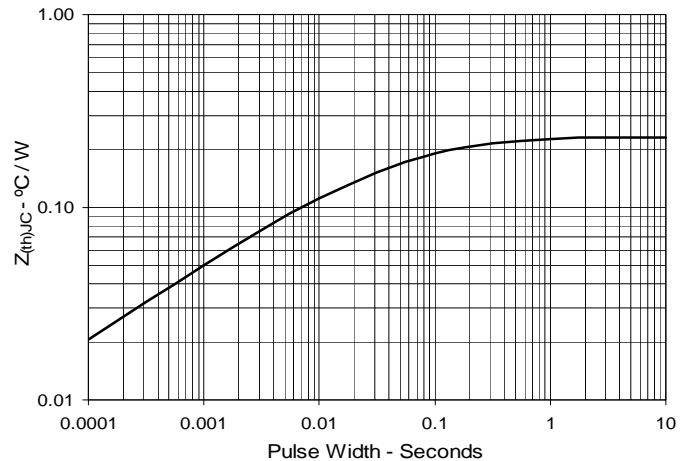


Fig. 13. Resistive Turn-on Rise Time vs. Junction Temperature

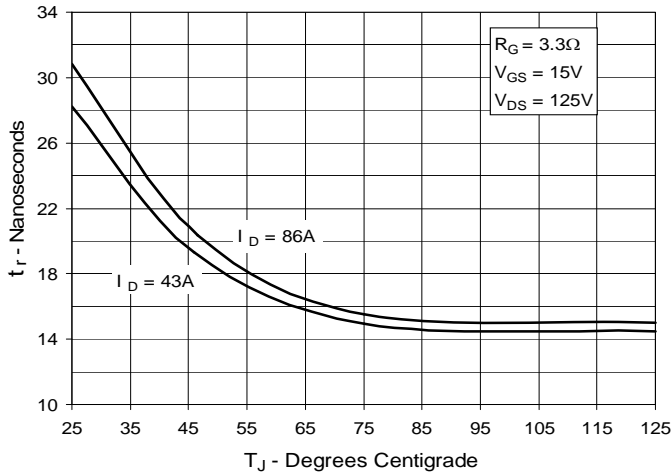


Fig. 14. Resistive Turn-on Rise Time vs. Drain Current

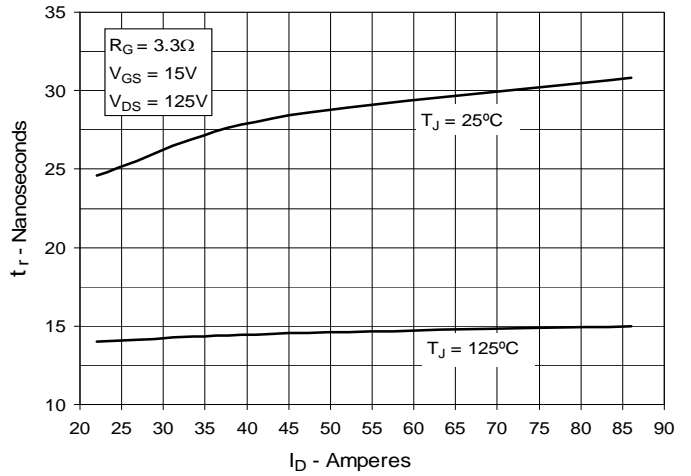


Fig. 15. Resistive Turn-on Switching Times vs. Gate Resistance

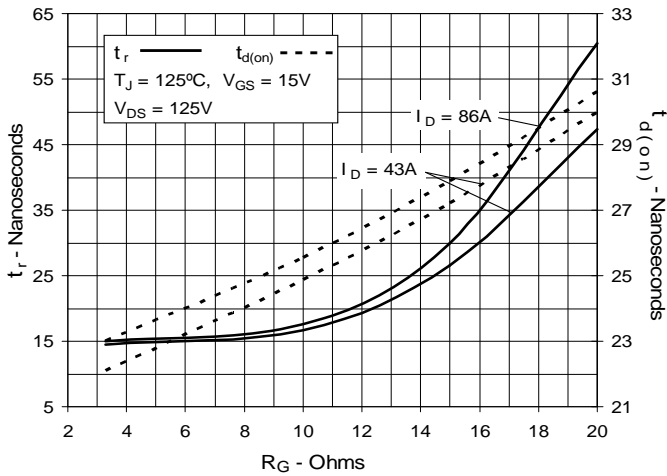


Fig. 16. Resistive Turn-off Switching Times vs. Junction Temperature

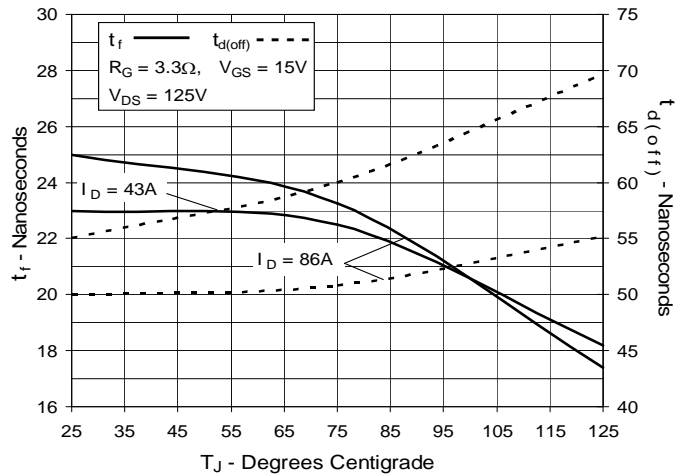


Fig. 17. Resistive Turn-off Switching Times vs. Drain Current

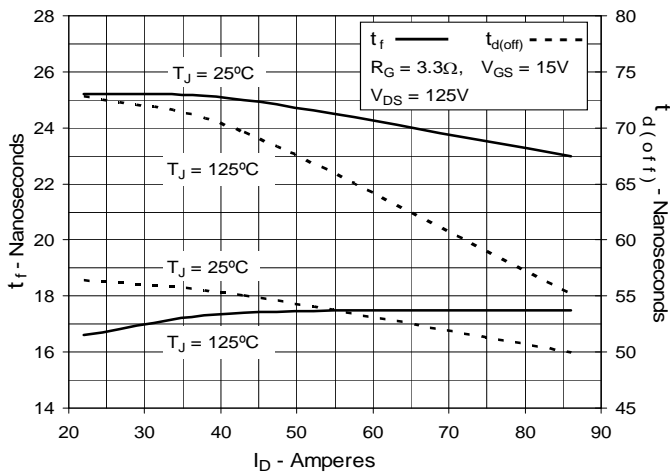
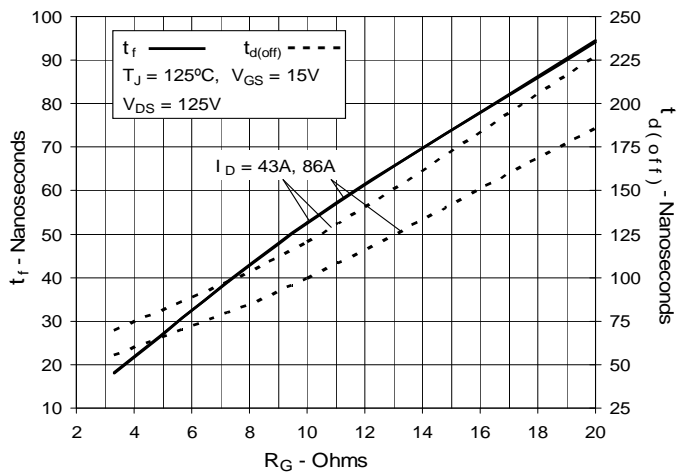


Fig. 18. Resistive Turn-off Switching Times vs. Gate Resistance





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